

09-29-2004

102847685

U.S. DEPARTMENT OF COMMERCE

OMB No. 0651-0027 (exp. 6/30/2005)	O.O. F along and Tradonian Onice	
To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.		
1. Name of conveying party(ies): ONO, Makoto ASAKAWA, Yohei	Name and address of receiving party(ies)     Name: HITACHI HIGH-TECHNOLOGIES     CORPORATION	
Additional name(s) of conveying party(les) attached? ☐ Yes ☒ No	Street Address: 24-14, Nishishinbashi 1-chome, Minato-ku, Tokyo, Japan	
Nature of conveyance:		
	Additional name(s) & address(es) attached? ☐ Yes ☒ No	
Application number(s) or patent number(s):     If this document is being filed together with a new application, the     A. Patent Application No.(s)	execution date of the application is:  B. Patent Registration No.(s)	
10/887,827 Filed July 12, 2004		
Additional number(s) attached ☐ Yes ☒ No		
Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved	
Name: Antonelli, Terry, Stout & Kraus, LLP	7. Total fee (37 CFR 3.41)\$ <b>40.00</b> ☑ Enclosed	
Internal Address:	☑ Authorized to be charged to deposit account	
1300 North Seventeenth Street Suite 1800 Arlington, VA 22209	8. Deposit account number:	
USA	01-2135	
City: State: Zip:	(Attach duplicate copy of this page if paying by deposit account)	
DO NOT USE THIS SPACE		
9. Statement and signature.  To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.		
Melvin Kraus, Reg#22,466 Name of Person Signing  Total number of access including access	_	
Total number of pages including cover sheet, attachments, and document: 2		

Mail documents to be recorded with required cover sheet information to:

Commissioner of Patent & Trademarks, Box Assignments

Washington, D.C. 20231

09/24/2004 EFLORES 00000039 10887827

02 FC:8021

40.00 OP

## ASSIGNMENT (譲渡証)

W1703-01 (\*)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi High-Technologies Corporation, a corporation organized under the laws of Japan,

located at 24-14, Nishishinbashi 1-chome, Minato-ku, Tokyo, Japan,

receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi High-Technologies Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

## INSPECTION DATA ANALYSIS PROGRAM, INSPECTION TOOLS, REVIEW APPARATUS AND YIELD ANALYSIS APPARATUS

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said Hitachi High-Technologies Corporation,

INVENTOR(S)

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made:

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi High-Technologies Corporation,

Signed on the date(s) indicated aside our signatures:

RECORDED: 09/23/2004

	(発明者フルネームサイン)	(署名日)
1)	Makoto Ono	July 5, 2004
2)	Yohei Asakawa	7/05/2004
5)		
6)		
7)		
8)		
9)		
10)		

PATENT REEL: 015821 FRAME: 0648

Date Signed